

DCR1473SY/SV

Phase Control Thyristor

Replaces June 2004 version DS4652-7.0

DS4652-8.0 JUNE 2006 (LN24655)

FEATURES

- Double Side Cooling
- High Surge Capability
- Low Turn-on Losses

APPLICATIONS

- High Voltage Power Converters
- DC Motor Control
- High Voltage Power Supplies

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{DRM} and V _{RRM} V	Conditions
DCR1473SY12	1200	T _{vi} = 0℃ to 125℃,
Or		$I_{DRM} = I_{RRM} = 250 \text{mA},$
DCR1473SV12	1200	V_{DRM} , $V_{RRM} t_p = 10ms$, $V_{DSM} \& V_{RSM} =$ $V_{DRM} \& V_{RRM} + 100V$ respectively

Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR1473SY12 for a 1200V 'Y' outline variant Or

DCR1473SV12 for a 1200V 'V' outline variant

If a lower voltage grade is required, then use $V_{\text{DRM}}/100$ for the grade required e.g.

DCR1473SY10 for a 1000V 'Y' outline variant

KEY PARAMETERS

1200V
4135A
64000A
1000V/µs
500A/µs

* Higher dV/dt selection available

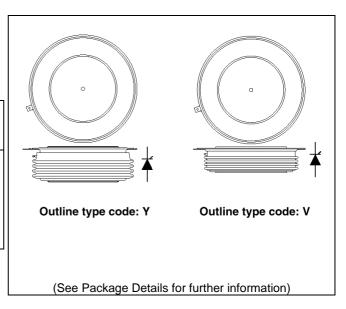


Fig. 1 Package outline

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.



CURRENT RATINGS

$T_{case} = 60^{\circ}C$ unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
I _{T(AV)}	Mean on-state current	Half wave resistive load	4135	А			
I _{T(RMS)}	RMS value	-	6495	А			
Ι _Τ	Continuous (direct) on-state current	-	5700	А			
Single Sid	Single Side Cooled (Anode side)						
I _{T(AV)}	Mean on-state current	Half wave resistive load	2605	А			
I _{T(RMS)}	RMS value	-	4090	А			
Ι _Τ	Continuous (direct) on-state current	-	3290	А			

$T_{case} = 80^{\circ}C$ unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
I _{T(AV}	Mean on-state current	Half wave resistive load	3190	А			
I _{T(RMS)}	RMS value	-	5010	А			
Ι _Τ	Continuous (direct) on-state current	-	3950	А			
Single Sid	Single Side Cooled (Anode side)						
I _{T(AV)}	Mean on-state current	Half wave resistive load	1966	А			
I _{T(RMS)}	RMS value	-	3090	А			
Ι _Τ	Continuous (direct) on-state current	-	2410	А			



SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125℃	51	kA
l ² t	I ² t for fusing	V _R = 50%VRRM - ¼ Sine	13.1×10 ⁶	A ² s
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125℃	64	kA
l ² t	I ² t for fusing	$V_R = 0$	20.48×10 ⁶	A ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC	-	0.0095	C/W
		Single side cooled	Anode DC	-	0.019	C/W
			Cathode DC	-	-	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Clamping force 43kN	Double side	-	0.002	C/W
		(with mounting compound)	Single side	-	0.004	C/W
T_{vj}	Virtual junction temperature	On-state (conducting)	state (conducting)		135	C
		Reverse (blocking)		-	125	C
T _{stg}	Storage temperature range			-55	125	C
Fm	Clamping force			38	47	kN



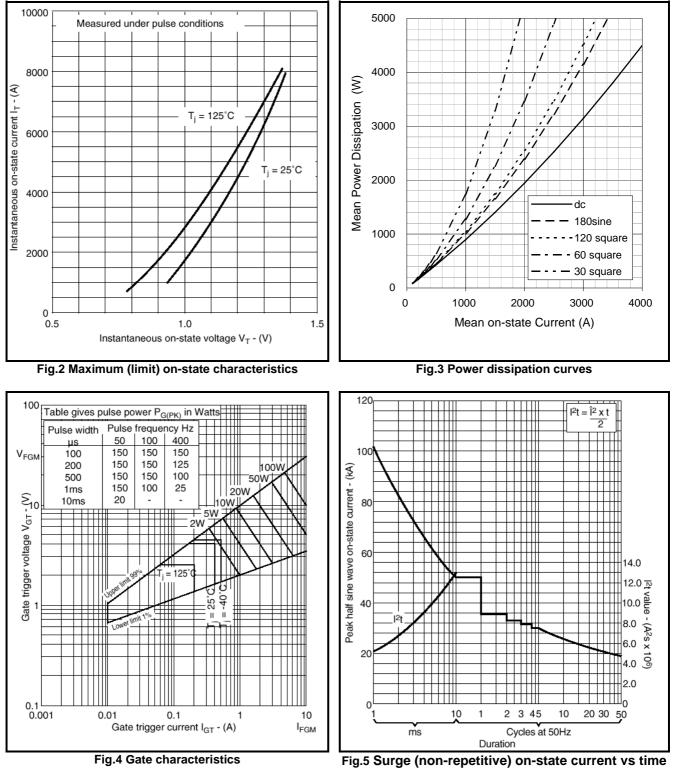
DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125℃		-	250	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V_{DRM} , T _j = 125°C, gate open		-	1000	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 1000A	Repetitive 50Hz	-	250	A/µs
		Gate source 20V, 10Ω, t _r = 0.5μs to 1A, T _j = 125℃	Non-repetitive	-	500	A/µs
V _{T(TO)}	Threshold voltage – Low level	At T _{vj} = 125℃		-	0.824	V
r _T	On-state slope resistance – Low level	At T _{vj} = 125℃		-	0.066	mΩ
t _{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source 30V, 15 Ω t _r = 0.5µs, T _j = 25°C		-	2	μs

GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V _{GT}	Gate trigger voltage	$V_{DRM} = 5V, T_{case} = 25$ °C	4	V
V_{GD}	Gate non-trigger voltage	At V _{DRM} , T _{case} = 125℃	0.25	V
I _{GT}	Gate trigger current	$V_{DRM} = 5V, T_{case} = 25$ °C	400	mA
V_{FGM}	Peak forward gate voltage	Anode positive with respect to cathode	30	V
V_{FGN}	Peak forward gate voltage	Anode negative with respect to cathode	0.25	V
V _{RGM}	Peak forward gate voltage	-	5	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	30	А
P _{GM}	Peak gate power	See Gate Characteristics curve/table	150	W
P _{G(AV)}	Mean gate power	-	10	W





(with 50%V_{RRM} at T_{case} 125℃)



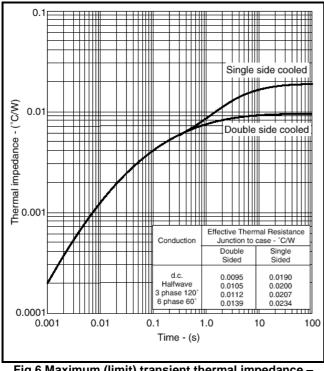


Fig.6 Maximum (limit) transient thermal impedance – junction to case (℃/kW)



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

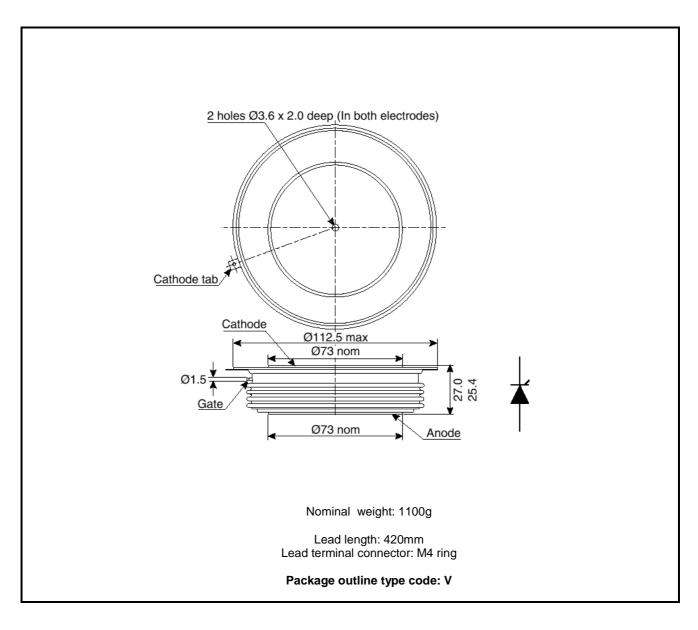


Fig.7 Package outline



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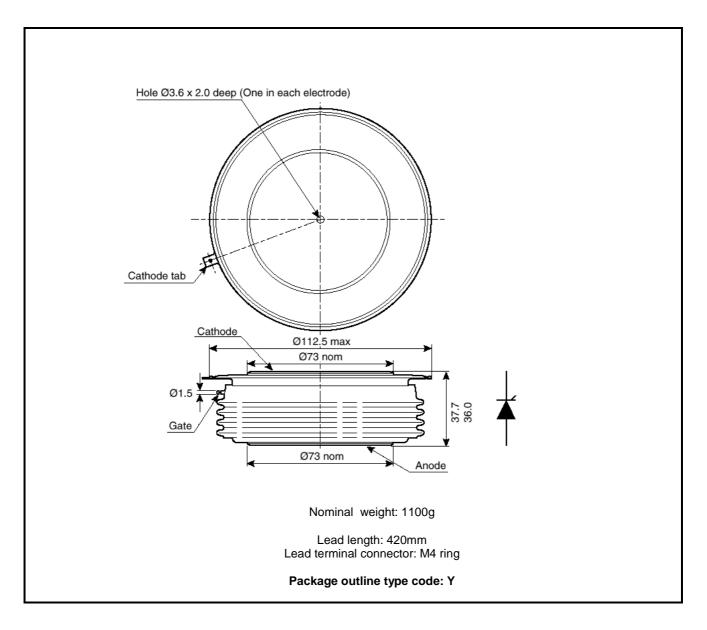


Fig.8 Package outline



POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink and clamping systems in line with advances in device voltages and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group offers high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the latest CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete Solution (PACs).

HEATSINKS

The Power Assembly group has its own proprietary range of extruded aluminium heatsinks which have been designed to optimise the performance of Dynex semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest sales representative or Customer Services.

Stresses above those listed in this data sheet may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed.



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